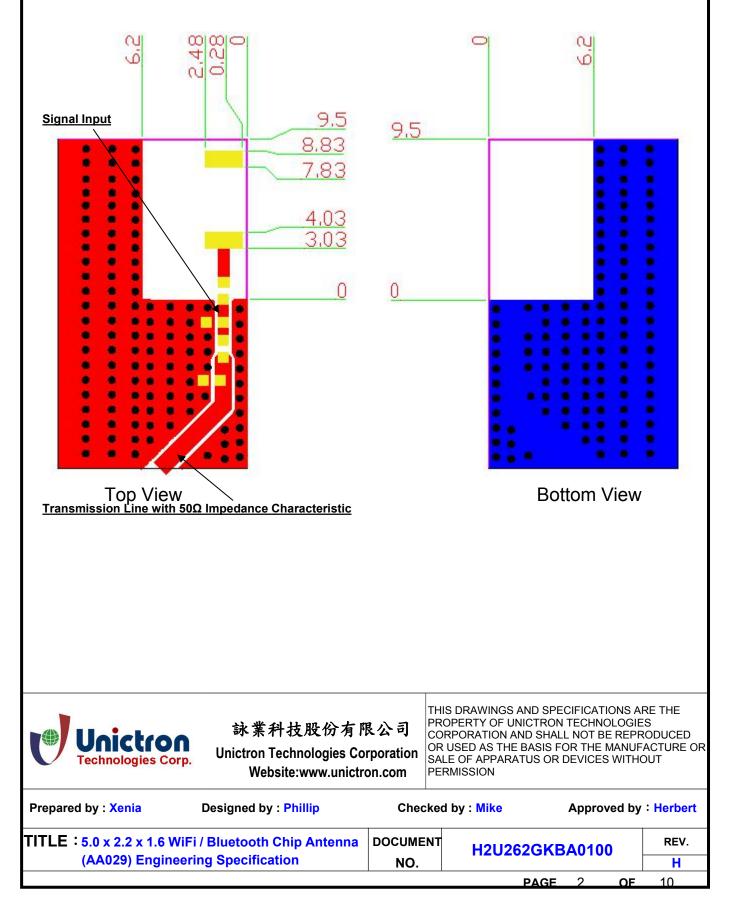


## 5. Layout Guide & Electrical Specifications

5-1. Layout Guide (unit : mm)

Solder Land Pattern:

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.

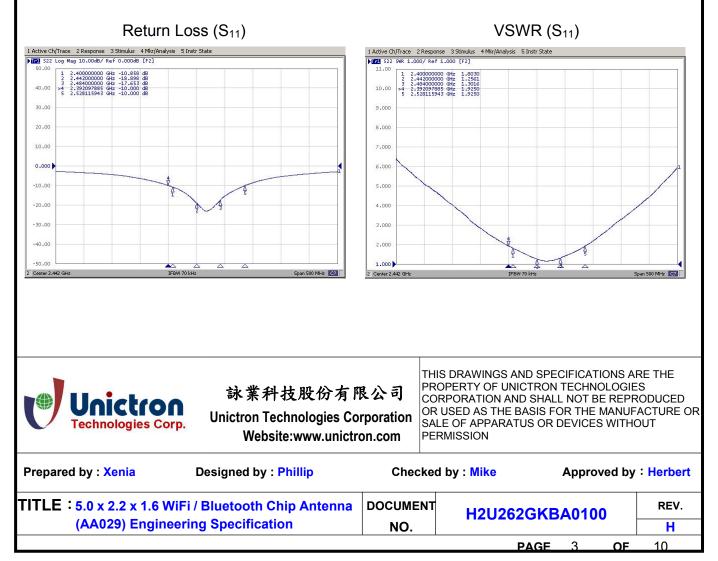


### 5-2. Electrical Specifications (Evaluation Board Dimensions: 40 x 40 mm<sup>2</sup>) 5-2-1. Electrical Table

Characte	ristics	Specifications	Unit			
Outline Dimensions		5.0 x 2.2 x 1.6	mm			
Working Frequency	,	2400 ~ 2500	MHz			
VSWR(@ center frequency)*		2 Max.				
Characteristic Impedance		50	Ω			
Polarization		Linear Polarization				
Peak Gain	(@2442 MU-)	2.2 (typical)	dBi			
Efficiency	(@2442 MHz)	66 (typical)	%			

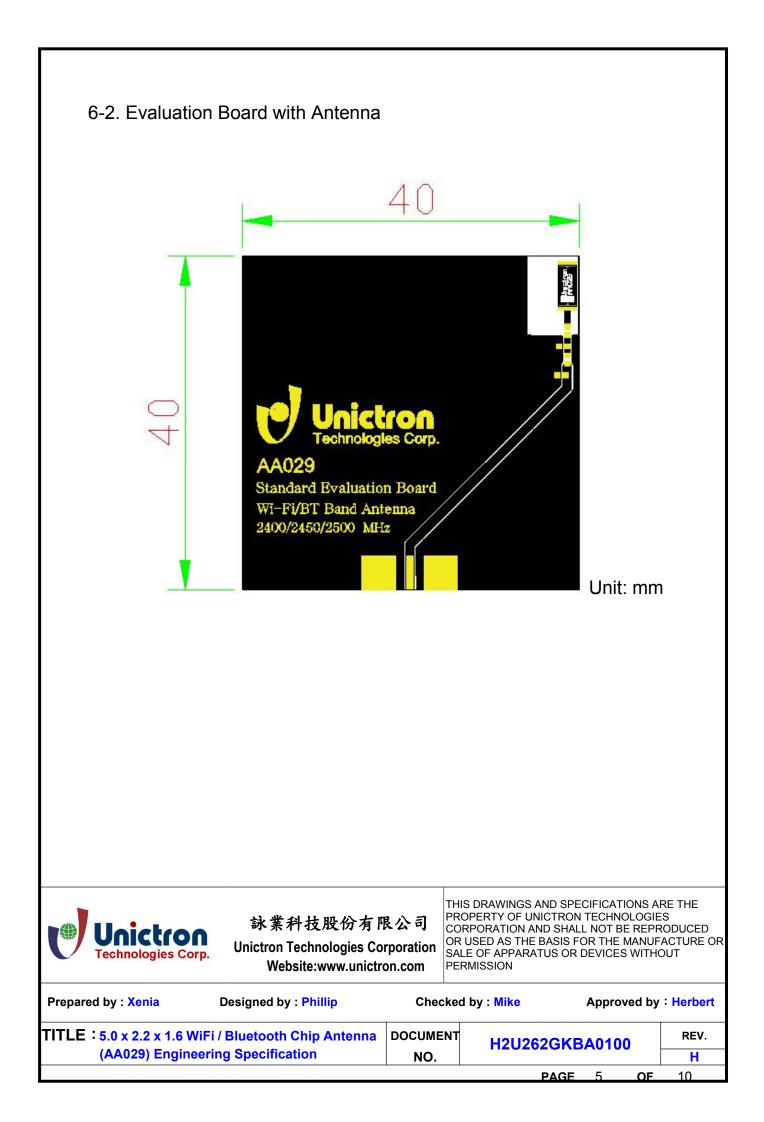
\*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board.

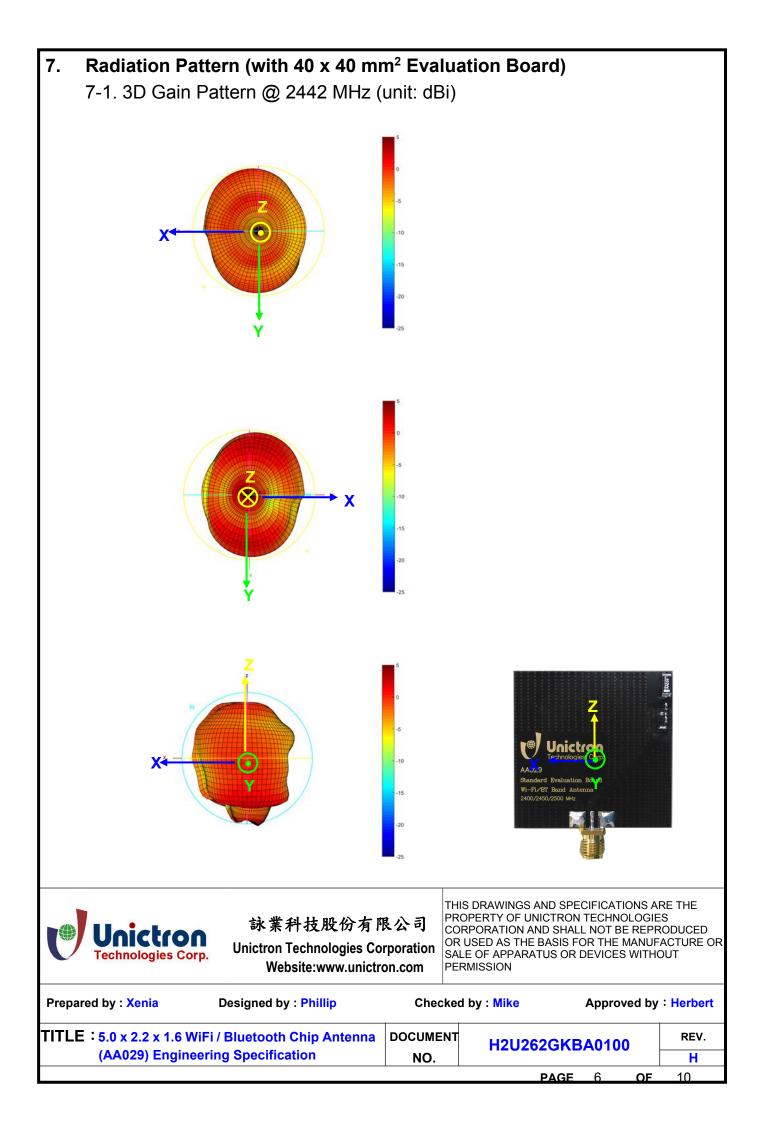
# 5-2. Return Loss & VSWR



<ol> <li>Outline Dimens</li> <li>6-1. Antenna Din</li> </ol>		Evaluat	ion Board (unit: mm)	
	05±0.35 Unictron AA029			
	1.6±0.15			
(0.3)	(0.3)		NOTE: 1.All materials are RoHS compliant. 2." (A)~ Critical Dimensions. 3."()" Reference Dimensions.	
	PIN Defi	nitions		
	AD29 PIN	12	•	
			Bottom View	
Тор	View		<b>Bottom View</b>	
-				
<b>Top</b> PIN Soldering PAD	View 1 Signal		2 N/C	
PIN	1 Signal	良公司 <sup>P</sup> C rporation S	2 N/C HIS DRAWINGS AND SPECIFICATIONS ARE TI ROPERTY OF UNICTRON TECHNOLOGIES ORPORATION AND SHALL NOT BE REPRODU R USED AS THE BASIS FOR THE MANUFACTU ALE OF APPARATUS OR DEVICES WITHOUT	ICED
PIN Soldering PAD	1 Signal 詠業科技股份有阿	<mark>良公司</mark> rporation <sup>O</sup> s on.com P	2 N/C HIS DRAWINGS AND SPECIFICATIONS ARE TI ROPERTY OF UNICTRON TECHNOLOGIES ORPORATION AND SHALL NOT BE REPRODU R USED AS THE BASIS FOR THE MANUFACTU	ICED JRE OR
PIN Soldering PAD	1 Signal 詠業科技股份有所 Unictron Technologies Co Website:www.unictro Designed by : Phillip	表公司 rporation on.com Check	2 N/C HIS DRAWINGS AND SPECIFICATIONS ARE TO ROPERTY OF UNICTRON TECHNOLOGIES ORPORATION AND SHALL NOT BE REPRODU R USED AS THE BASIS FOR THE MANUFACTO ALE OF APPARATUS OR DEVICES WITHOUT ERMISSION ed by : Mike Approved by : He	JCED URE OR
PIN Soldering PAD	1 Signal 家業科技股份有所 Unictron Technologies Co Website:www.unictro Designed by : Phillip Bluetooth Chip Antenna	<mark>良公司</mark> rporation <sup>O</sup> s on.com P	2 N/C HIS DRAWINGS AND SPECIFICATIONS ARE TO ROPERTY OF UNICTRON TECHNOLOGIES ORPORATION AND SHALL NOT BE REPRODU R USED AS THE BASIS FOR THE MANUFACTO ALE OF APPARATUS OR DEVICES WITHOUT ERMISSION ed by : Mike Approved by : He	ICED JRE OR

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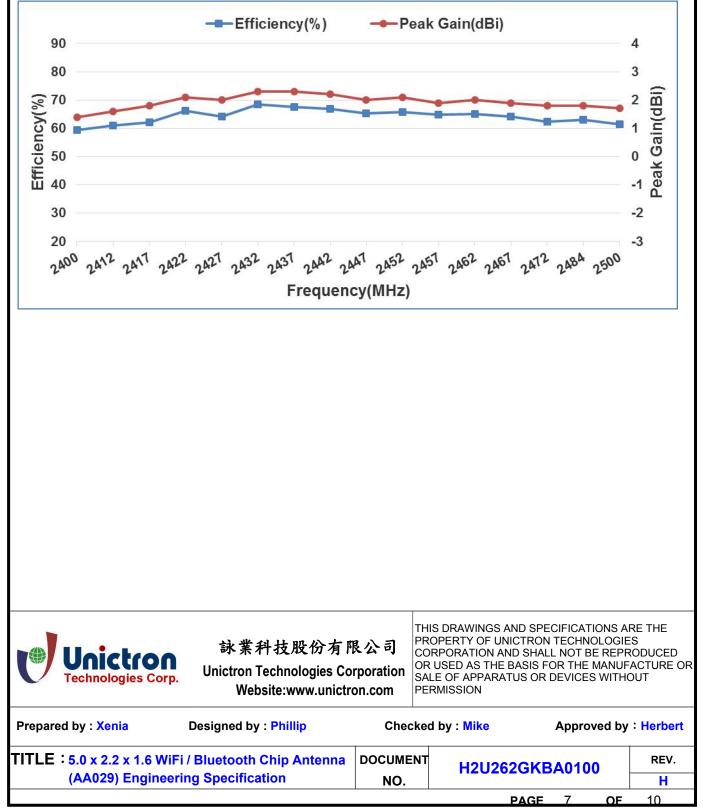


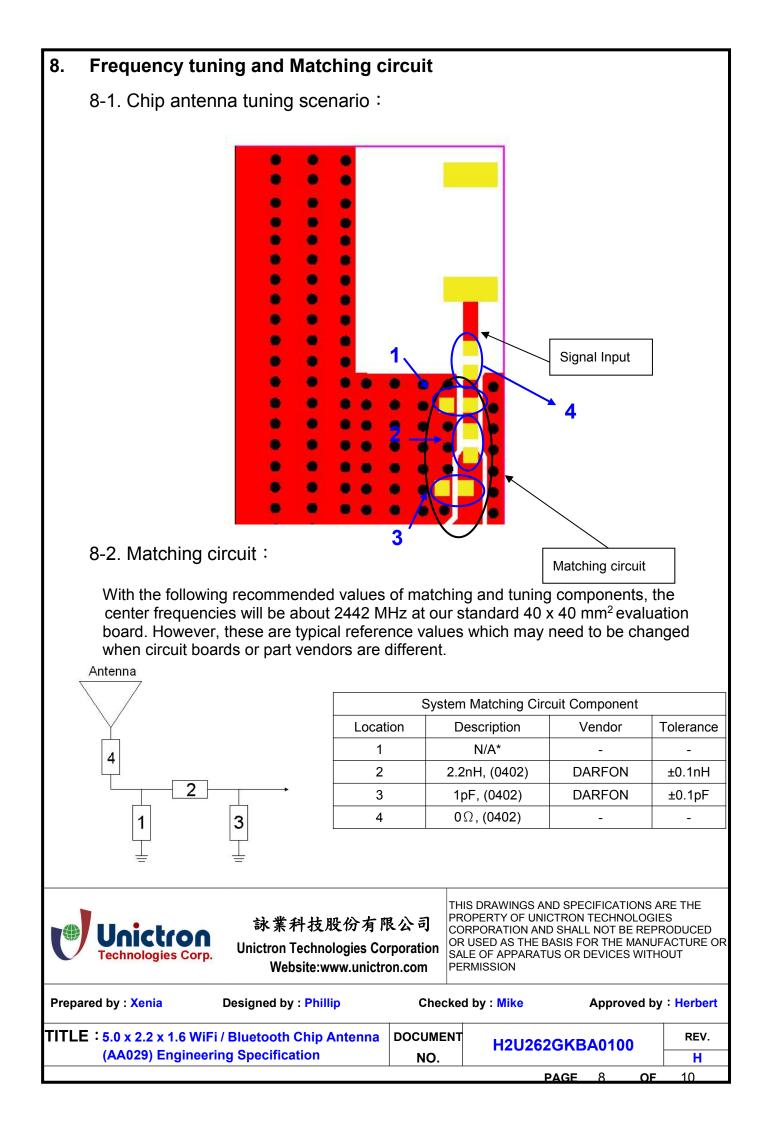


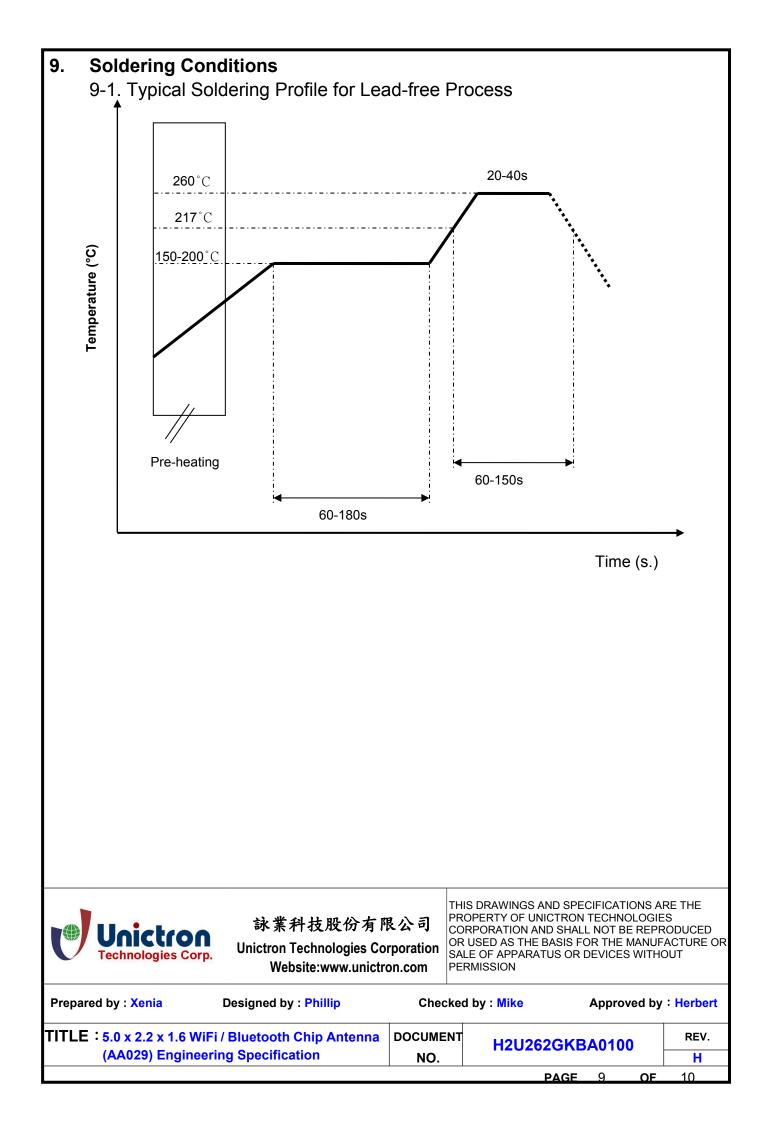
# 7-2. 3D Efficiency Table

Frequency(MHz)	2400	2412	2417	2422	2427	2432	2437	2442	2447	2452	2457	2462	2467	2472	2484	2500
Efficiency(dB)	-2.3	-2.2	-2.1	-1.8	-1.9	-1.6	-1.7	-1.8	-1.9	-1.8	-1.9	-1.9	-1.9	-2.0	-2.0	-2.1
Efficiency(%)	59.3	60.9	62.2	66.1	64.2	68.4	67.5	66.8	65.2	65.8	64.8	65.1	64.0	62.4	63.0	61.5
Peak Gain(dBi)	1.4	1.6	1.8	2.1	2.0	2.3	2.3	2.2	2.0	2.1	1.9	2.0	1.9	1.8	1.8	1.7





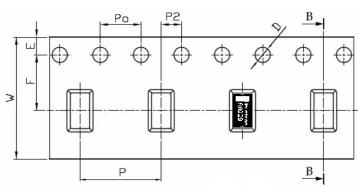




# 10. Packing

- (1) Quantity/Reel: 3000pcs/Reel
- (2) Plastic tape:

a. Tape Drawing



b. Tape Dimensions (unit: mm)

Footuro	Specifications	Tolerances
геаше		TOIETATICES
W	12.00	±0.30
Р	8.00	±0.10
E	1.75	±0.10
F	5.50	±0.10
P2	2.00	±0.10
D	1 50	+0.10
	1.50	-0.00
Po	4.00	±0.10
10Po	40.00	±0.20
	P E F P2 D Po	W     12.00       P     8.00       E     1.75       F     5.50       P2     2.00       D     1.50       Po     4.00

# 11. Operating & Storage Conditions

- 11-1. Operating
  - (1) Maximum Input Power: 2 W
  - (2) Operating Temperature: -40  $^\circ\!\mathrm{C}$  to 85  $^\circ\!\mathrm{C}$

#### 11-2. Storage

- (1) Storage Temperature: -5°C to 40°C
- (2) Relative Humidity: 20% to 70%
- (3) Shelf Life: 1 year

### 12. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.

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Prepared by : Xenia	Designed by : Phillip	Checl	ked by : Mike	Approved by	: Herbert		
TITLE :5.0 x 2.2 x 1.6 WiFi / Bluetooth Chip Antenna (AA029) Engineering Specification		DOCUMENNO.	H2U262GKB	A0100	REV.		
			PAGE	10 <b>OF</b>	10		